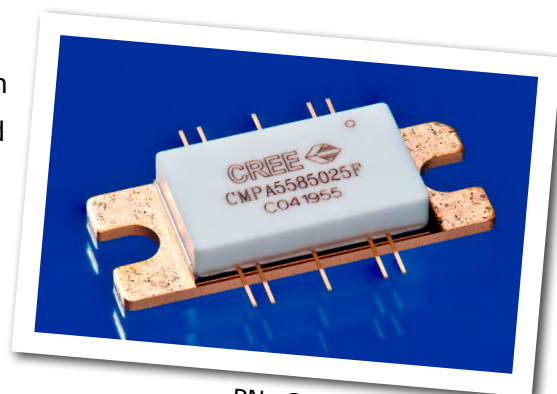


CPA5585025F

25 W, 5.5 - 8.5 GHz, GaN MMIC, Power Amplifier

Cree's CPA5585025F is a gallium nitride (GaN) High Electron Mobility Transistor (HEMT) based monolithic microwave integrated circuit (MMIC). GaN has superior properties compared to silicon or gallium arsenide, including higher breakdown voltage, higher saturated electron drift velocity and higher thermal conductivity. GaN HEMTs also offer greater power density and wider bandwidths compared to Si and GaAs transistors. This MMIC is available in a 10 lead metal/ceramic flanged package for optimal electrical and thermal performance.



PN: CPA5585025F
Package Type: 440208

Typical Performance Over 5.8-8.4 GHz ($T_c = 25^\circ\text{C}$)

Parameter	5.8 GHz	6.4 GHz	7.2 GHz	7.9 GHz	8.4 GHz	Units
Small Signal Gain	29.5	24.0	24.0	24.0	22.0	dB
Output Power ¹	15	23	20	19	19	W
Power Gain ¹	22.5	20.0	18.5	17.5	20.0	dB
Power Added Efficiency ¹	30	35	30	25	30	%

Note¹: Measured at -30 dBc, 1.6 MHz from carrier, in the CPA5585025F-TB under OQPSK modulation, 1.6 Msps, PN23, Alpha Filter = 0.2.

Features

- 25 dB Small Signal Gain
- 35 W Typical P_{SAT}
- Operation up to 28 V
- High Breakdown Voltage
- High Temperature Operation
- Size 1.00 x 0.385 inches

Applications

- Point to Point Radio
- Communications
- Satellite Communication Uplink

Absolute Maximum Ratings (not simultaneous)

Parameter	Symbol	Rating	Units	Conditions
Drain-source Voltage	V_{DS}	84	V_{DC}	25°C
Gate-source Voltage	V_{GS}	-10, +2	V_{DC}	25°C
Power Dissipation	P_{DISS}	55	W	
Storage Temperature	T_{STG}	-65, +150	°C	
Operating Junction Temperature	T_J	225	°C	
Maximum Forward Gate Current	I_{GMAX}	10	mA	25°C
Soldering Temperature ¹	T_S	245	°C	
Screw Torque	τ	40	in-oz	
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.55	°C/W	OQPSK, 85°C, $P_{DISS} = 55$ W
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.80	°C/W	CW, 85°C, $P_{DISS} = 77$ W
Case Operating Temperature	T_C	-40, +140	°C	$P_{DISS} = 55$ W
Case Operating Temperature	T_C	-40, +85	°C	$P_{DISS} = 77$ W

Note:

¹ Refer to the Application Note on soldering at www.cree.com/products/wireless_appnotes.asp

Electrical Characteristics (Frequency = 5.5 GHz to 8.5 GHz unless otherwise stated; $T_C = 25^\circ\text{C}$)

Characteristics	Symbol	Min.	Typ.	Max.	Units	Conditions
DC Characteristics¹						
Gate Threshold Voltage	$V_{GS(TH)}$	-3.8	-3.0	-2.3	V	$V_{DS} = 10$ V, $I_D = 13.2$ mA
Gate Quiescent Voltage	$V_{GS(Q)}$	-	-2.7	-	V_{DC}	$V_{DS} = 28$ V, $I_D = 285$ A
Saturated Drain Current ²	I_{DS}	10.6	12.8	-	A	$V_{DS} = 6.0$ V, $V_{GS} = 2.0$ V
Drain-Source Breakdown Voltage	V_{BD}	84	100	-	V	$V_{GS} = -8$ V, $I_D = 13.2$ mA
RF Characteristics³						
Small Signal Gain	S21	18.25	24	-	dB	$V_{DD} = 28$ V, $I_{DQ} = 285$ mA, $P_{IN} = -20$ dBm
Input Return Loss	S11	-	10	-	dB	$V_{DD} = 28$ V, $I_{DQ} = 285$ mA
Output Return Loss	S22	-	6	-	dB	$V_{DD} = 28$ V, $I_{DQ} = 285$ mA
Output Mismatch Stress	VSWR	-	-	5:1	Ψ	No damage at all phase angles, $V_{DD} = 28$ V, $I_{DQ} = 285$ mA, $P_{OUT} = 25$ W OQPSK

Notes:

¹ Measured on-wafer prior to packaging.

² Scaled from PCM data.

³ Measured in the CMPA5585025F-TB.



Electrical Characteristics Continued... ($T_c = 25^\circ\text{C}$)

Characteristics	Symbol	Min.	Typ.	Max.	Units	Conditions
RF Characteristics^{1,2,3,4}						
Power Added Efficiency	PAE1	20.0	24.5	–	%	$V_{DD} = 28\text{ V}$, $I_{DQ} = 285\text{ mA}$, Frequency = 5.8 GHz
Power Added Efficiency	PAE2	17.0	21.0	–	%	$V_{DD} = 28\text{ V}$, $I_{DQ} = 285\text{ mA}$, Frequency = 7.2 GHz
Power Added Efficiency	PAE3	16.0	19.0	–	%	$V_{DD} = 28\text{ V}$, $I_{DQ} = 285\text{ mA}$, Frequency = 7.9 GHz
Power Added Efficiency	PAE4	17.5	21.5	–	%	$V_{DD} = 28\text{ V}$, $I_{DQ} = 285\text{ mA}$, Frequency = 8.4 GHz
Power Gain	G_{P1}	19.5	23.0	–	dB	$V_{DD} = 28\text{ V}$, $I_{DQ} = 285\text{ mA}$, Frequency = 5.8 GHz
Power Gain	G_{P2}	17.1	19.0	–	dB	$V_{DD} = 28\text{ V}$, $I_{DQ} = 285\text{ mA}$, Frequency = 7.2 GHz
Power Gain	G_{P3}	17.3	19.5	–	dB	$V_{DD} = 28\text{ V}$, $I_{DQ} = 285\text{ mA}$, Frequency = 7.9 GHz
Power Gain	G_{P4}	18.5	21.5	–	dB	$V_{DD} = 28\text{ V}$, $I_{DQ} = 285\text{ mA}$, Frequency = 8.4 GHz
OQPSK Linearity	ACLR1	–	-34.5	-28.5	dB	$V_{DD} = 28\text{ V}$, $I_{DQ} = 285\text{ mA}$, Frequency = 5.8 GHz
OQPSK Linearity	ACLR2	–	-37.5	-30.0	dB	$V_{DD} = 28\text{ V}$, $I_{DQ} = 285\text{ mA}$, Frequency = 7.2 GHz
OQPSK Linearity	ACLR3	–	-31.0	-26.0	dB	$V_{DD} = 28\text{ V}$, $I_{DQ} = 285\text{ mA}$, Frequency = 7.9 GHz
OQPSK Linearity	ACLR4	–	-38.5	-32.5	dB	$V_{DD} = 28\text{ V}$, $I_{DQ} = 285\text{ mA}$, Frequency = 8.4 GHz

Notes:

¹ Measured in the CMPA5585025F-TB.

² Under OQPSK modulated signal, 1.6 Msps, PN23, Alpha Filter = 0.2.

³ Measured at $P_{AVE} = 40\text{ dBm}$.

⁴ Fixture loss de-embedded.

Electrostatic Discharge (ESD) Classifications

Parameter	Symbol	Class	Test Methodology
Human Body Model	HBM	1A (> 250 V)	JEDEC JESD22 A114-D
Charge Device Model	CDM	II (200 < 500 V)	JEDEC JESD22 C101-C

Typical Performance of the CMPA5585025F

Figure 1. CMPA5585025F Linear Output Power, Gain and PAE at -30 dBc, 1.6 MHz from carrier
 $V_{DD} = 28\text{ V}$, $I_{DQ} = 285\text{ mA}$, 1.6 Msps OQPSK Modulation

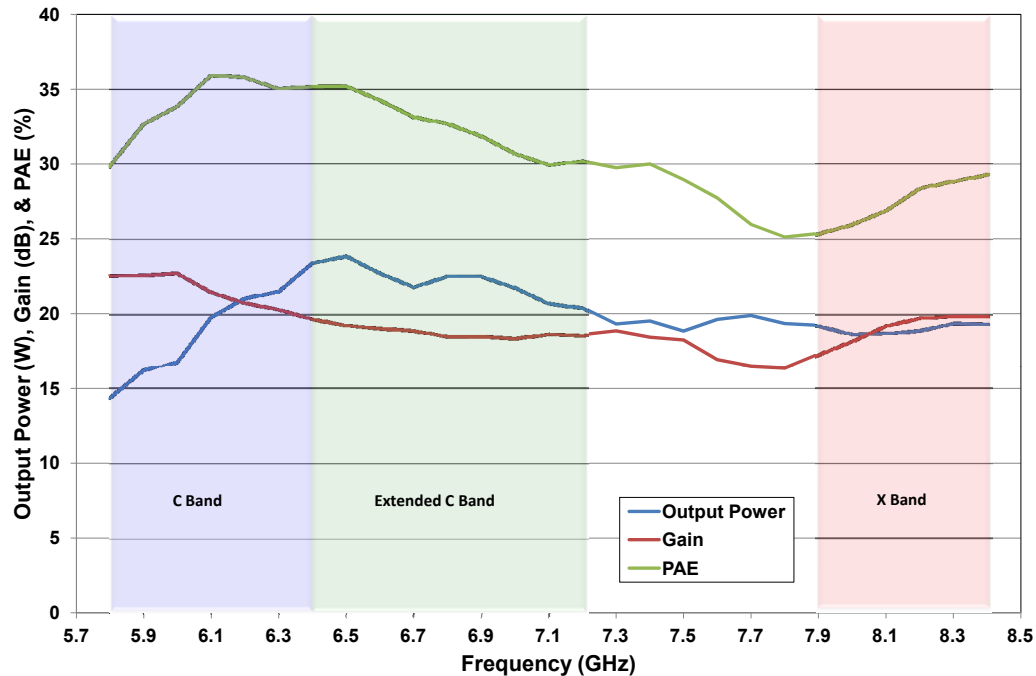
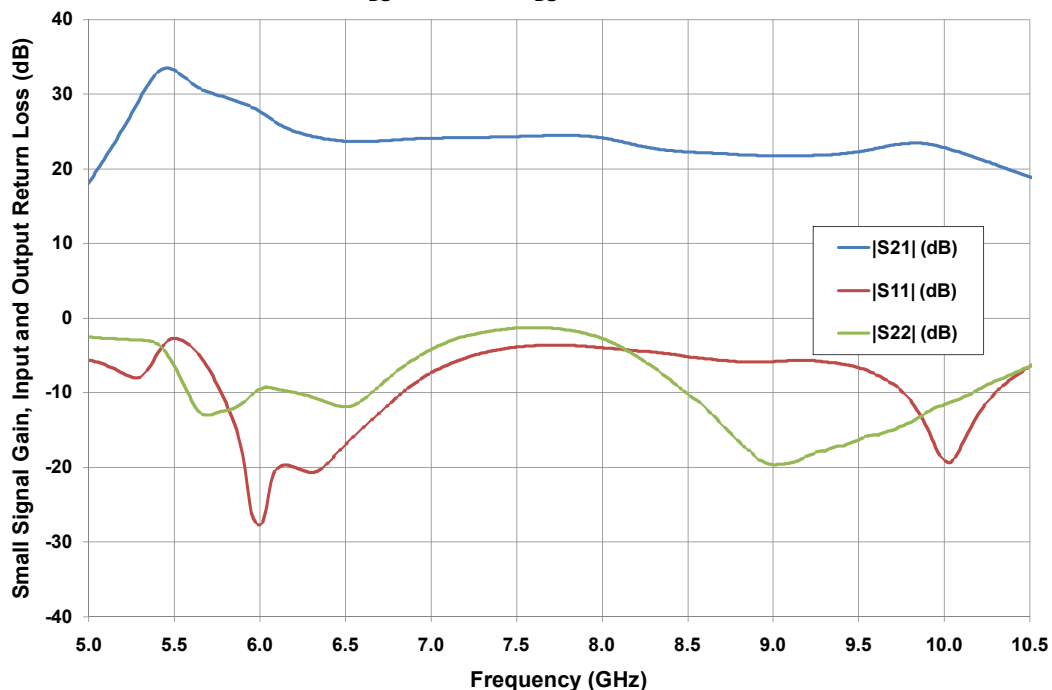


Figure 2. Typical Small Signal Gain and Return Loss vs Frequency of the CMPA5585025F measured in CMPA5585025F-TB Amplifier Circuit.
 $V_{DS} = 28\text{ V}$, $I_{DS} = 285\text{ mA}$



Typical Performance of the CMPA5585025F

Figure 3. CMPA5585025F C-band Spectral Mask at 15 W
PAE = 29.1% at 5.8 GHz, 28.5% at 6.4 GHz & 25.6% at 7.2 GHz

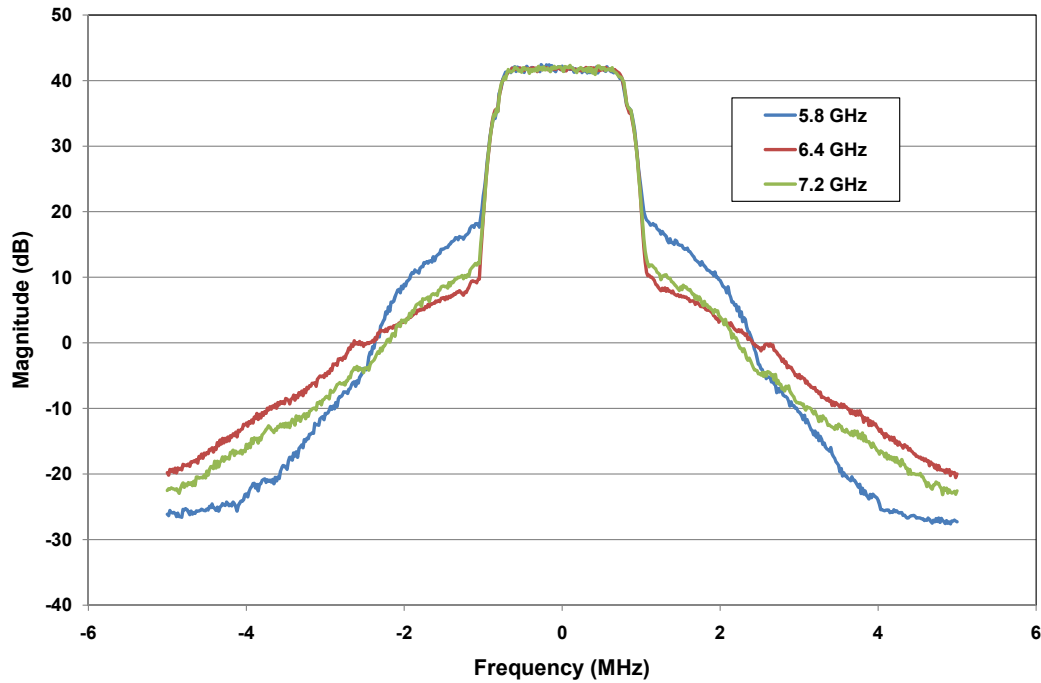
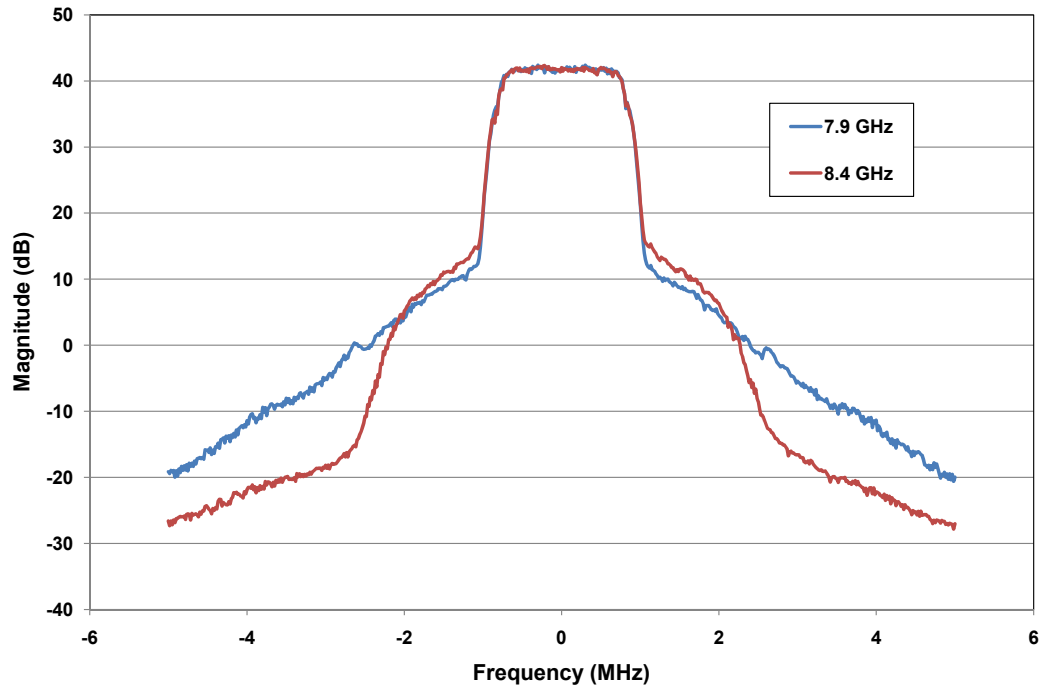


Figure 4. CMPA5585025F X-band Spectral Mask at 15 W
PAE = 25.6% at 7.9 GHz & 25.3% at 8.4 GHz



Typical Performance of the CMPA5585025F

Figure 5. CMPA5585025F C-band Linearity, Gain, and PAE vs Average Output Power
 $V_{DS} = 28\text{ V}$, $I_{DS} = 285\text{ mA}$, OQPSK, 1.6 Msps

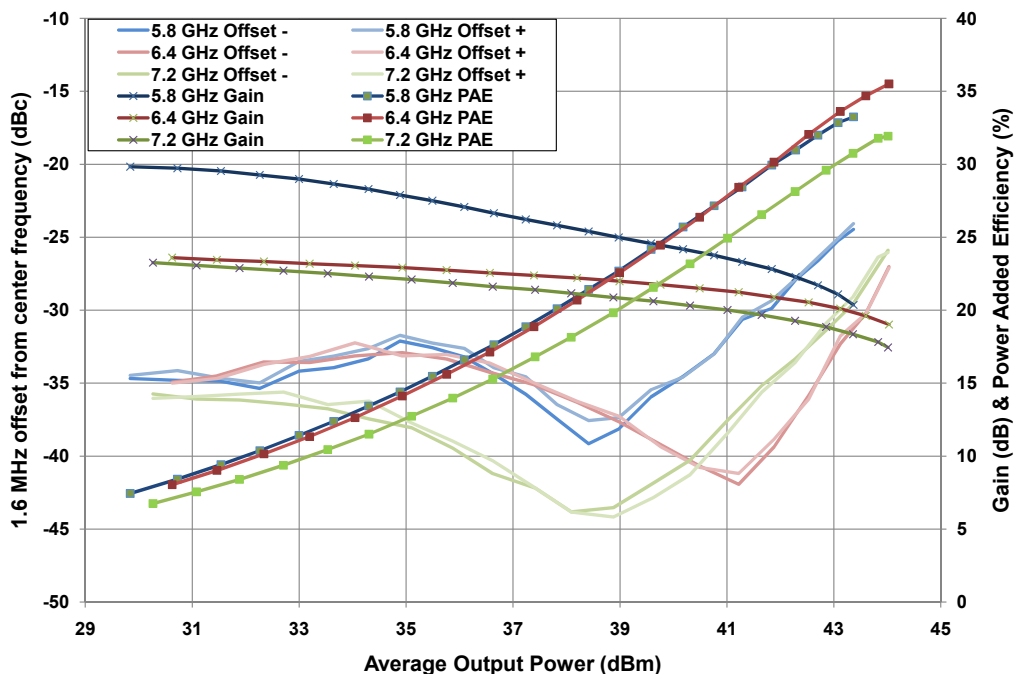
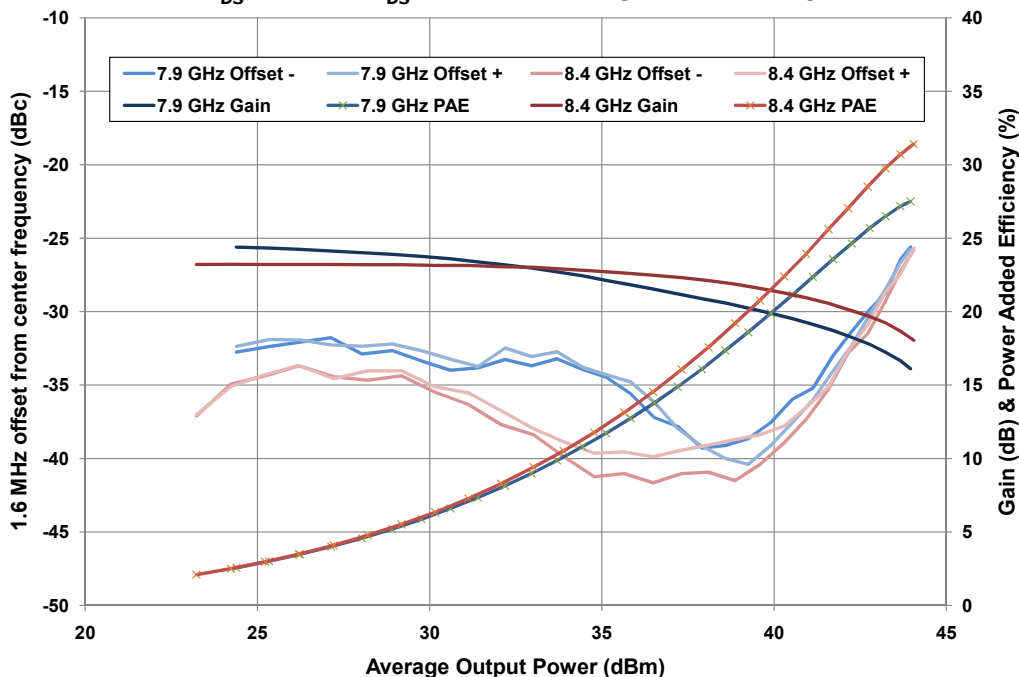


Figure 6. CMPA5585025F X-band Linearity, Gain, and PAE vs Average Output Power
 $V_{DS} = 28\text{ V}$, $I_{DS} = 285\text{ mA}$, OQPSK, 1.6 Msps



Typical Performance of the CMPA5585025F

Figure 7. CMPA5585025F EVM vs Average Output Power
 $V_{DS} = 28\text{ V}$, $I_{DS} = 285\text{ mA}$, 1.6 Msps OQPSK Modulation

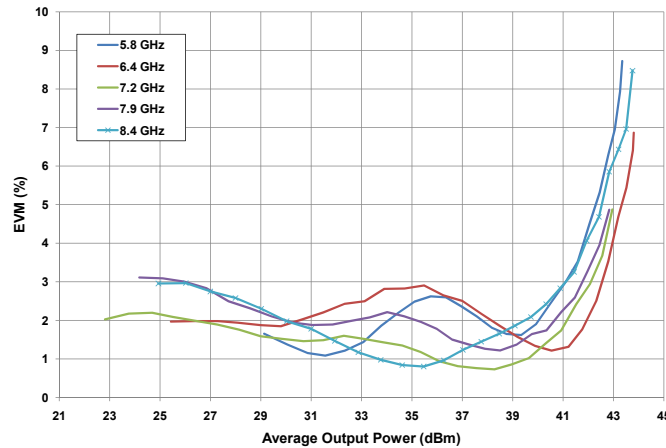


Figure 8. CMPA5585025F - Linearity vs Average Output Power
 OQPSK, 1.6 Msps, $I_{DS} = 285\text{ mA}$

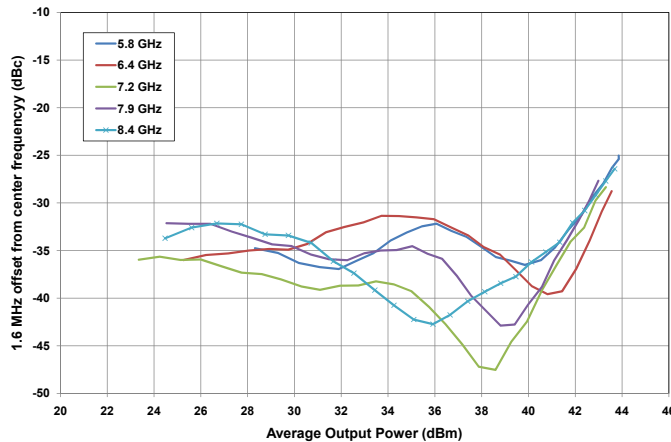
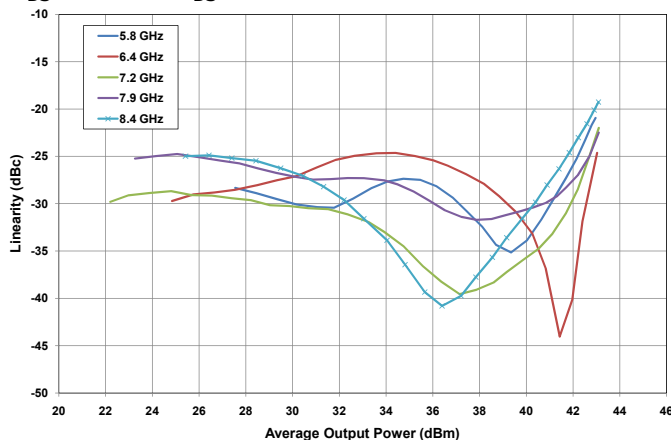


Figure 9. CMPA5585025F Linearity vs Average Output Power
 $V_{DS} = 28\text{ V}$, $I_{DS} = 285\text{ mA}$, IM3 5 MHz spacing



Typical Performance of the CMPA5585025F

Figure 10. CMPA5585025F - C-band Output Power, Gain and PAE vs Input Power
 $V_{DS} = 28\text{ V}$, $I_{DS} = 1.2\text{ A}$, CW

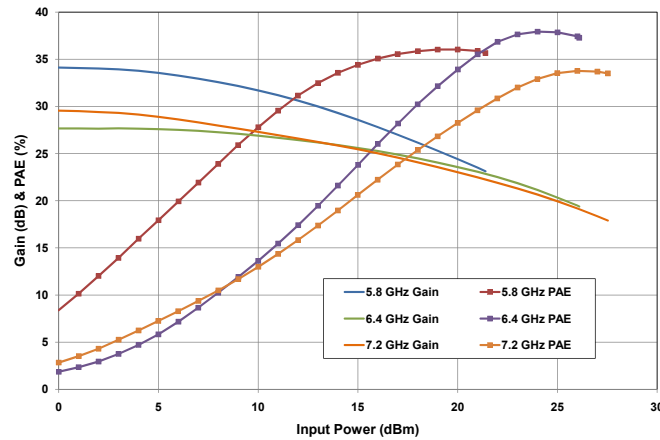


Figure 11. CMPA5585025F - X-band Output Power, Gain and PAE vs Input Power
 $V_{DS} = 28\text{ V}$, $I_{DS} = 1.2\text{ A}$, CW

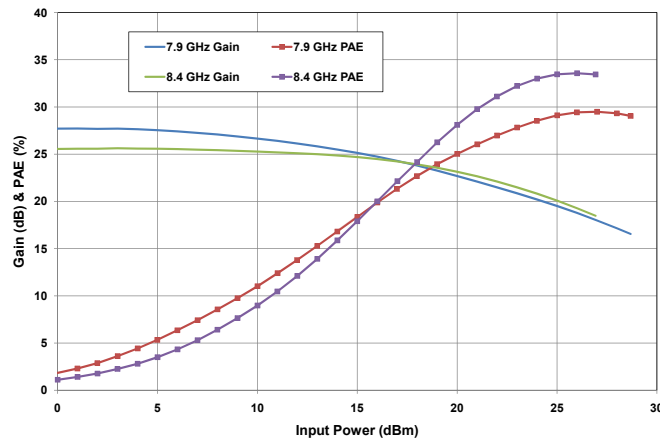
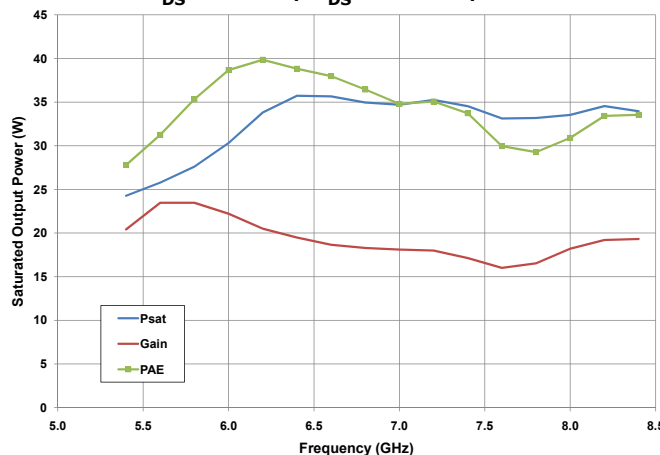


Figure 12. CMPA5585025F - Power, Gain and PAE vs Frequency
 $V_{DS} = 28\text{ V}$, $I_{DS} = 1.2\text{ A}$, CW



Typical Performance of the CMPA5585025F

Figure 13. CMPA5585025F - Typical Drain Current vs Average Output Power
 $V_{DS} = 28\text{ V}$, $I_{DS} = 285\text{ mA}$, QPSK, 1.6 Msps

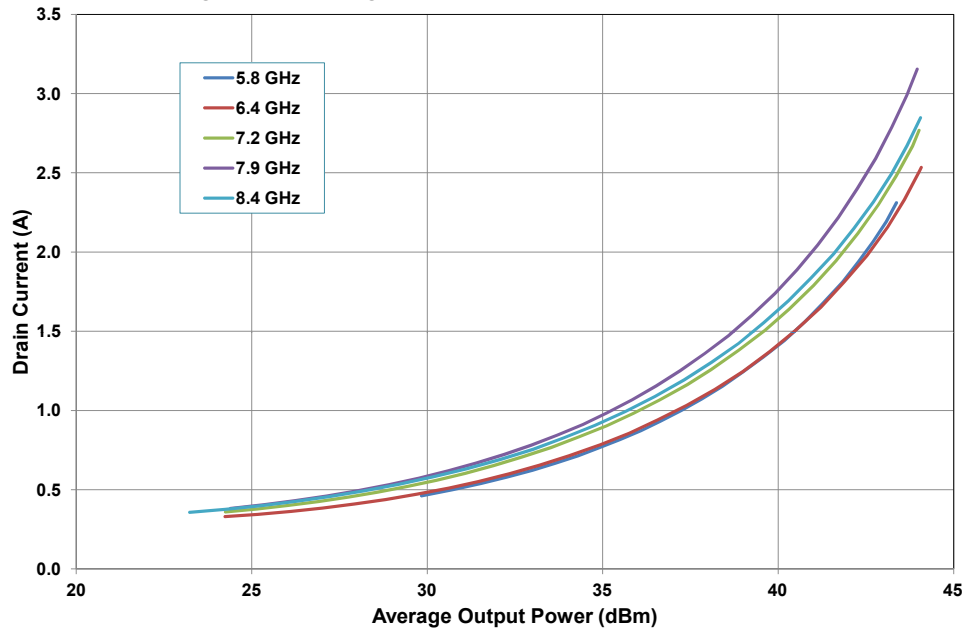
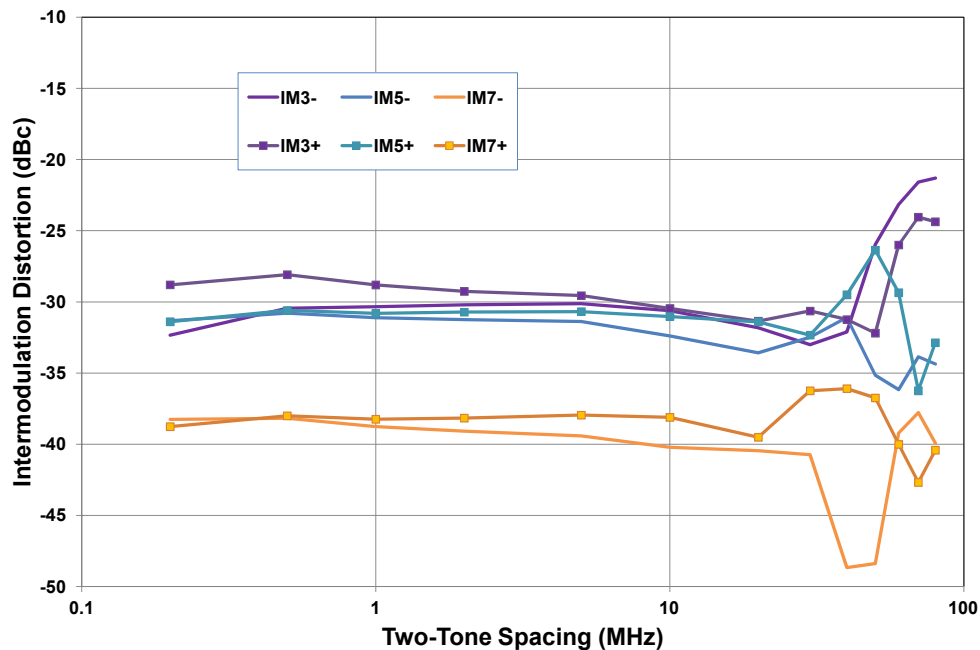


Figure 14. CMPA5585025F - Intermodulation Distortion Products vs Tone Spacing
 $V_{DS} = 28\text{ V}$, $I_{DS} = 285\text{ mA}$, Center Freq = 7.9 GHz



Note: Divergence in IM5 and IM7 at tone spacings greater than 20 MHz is due to the bias components on the test fixture.

Typical Performance of the CMPA5585025F

Figure 15. CMPA5585025F - AM-AM

$V_{DS} = 28\text{ V}$, $I_{DS} = 285\text{ mA}$

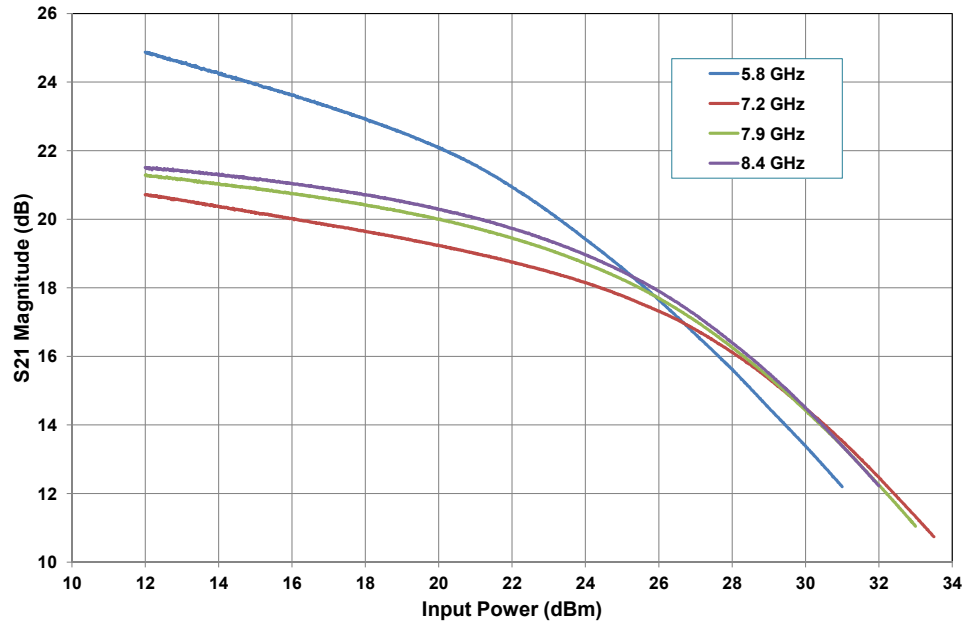
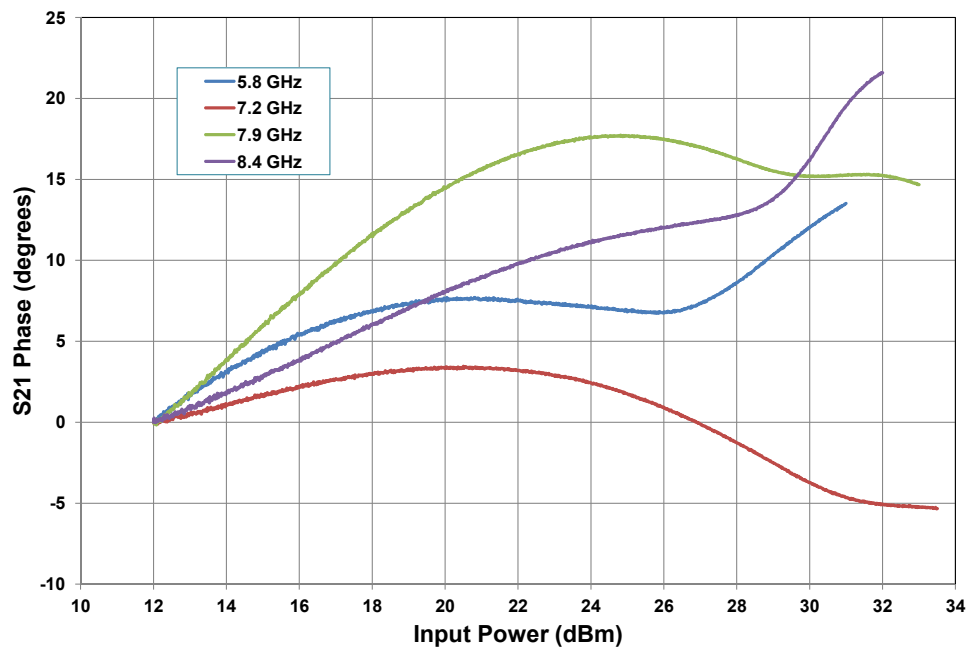


Figure 16. CMPA5585025F -Normalized AM-PM

$V_{DS} = 28\text{ V}$, $I_{DS} = 285\text{ mA}$



Typical Performance of the CMPA5585025F

Figure 17. CMPA5585025F EVM vs Average Output Power
 $V_{DS} = 28\text{ V}$, $I_{DS} = 285\text{ mA}$, 256 QAM

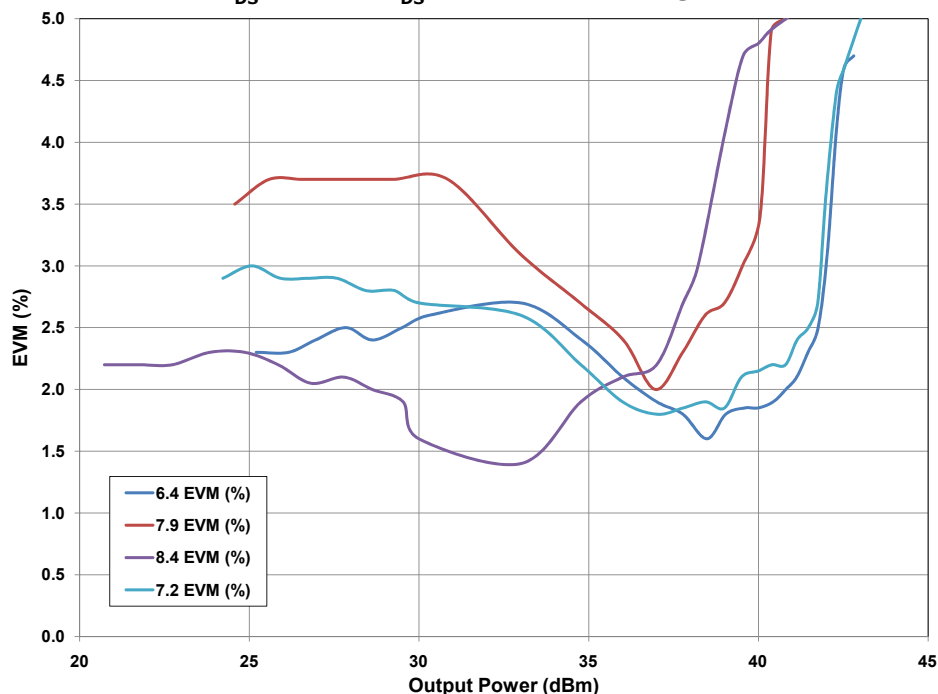
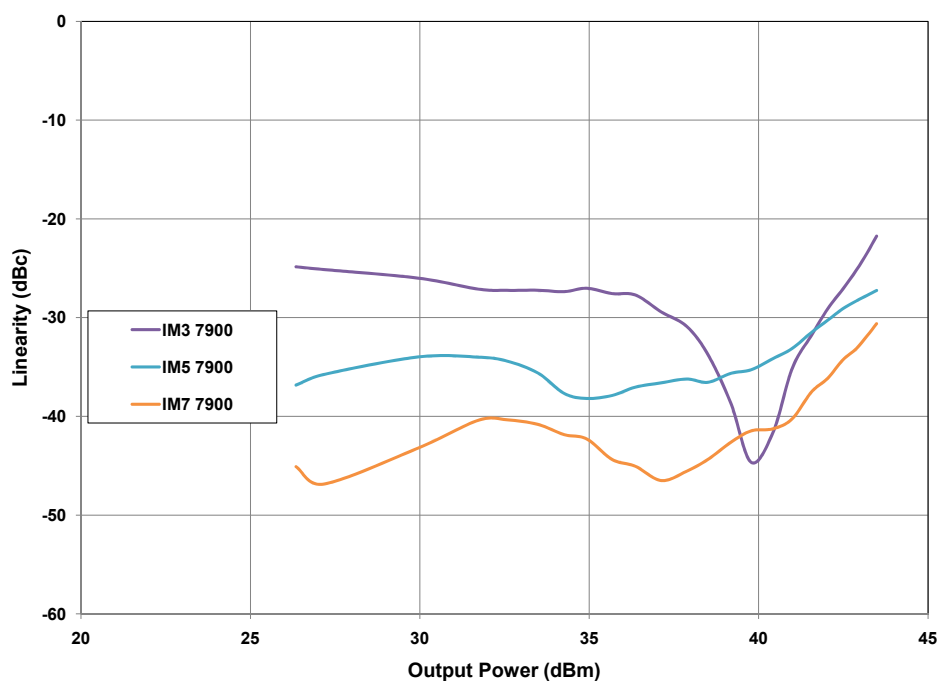
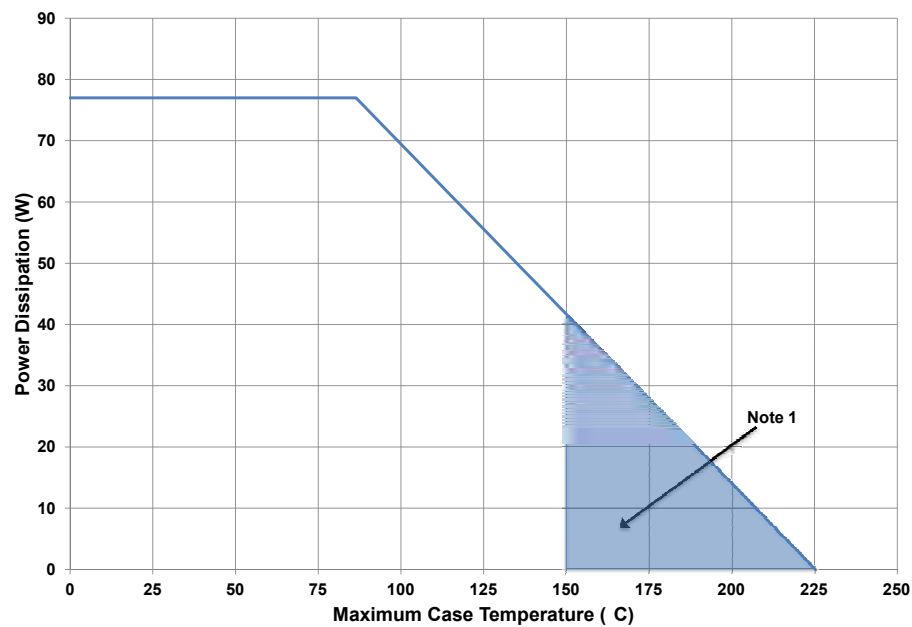


Figure 18. CMPA5585025F Linearity vs Average Output Power
 $V_{DS} = 28\text{ V}$, $I_{DS} = 285\text{ mA}$, IM3, IM5, IM7, 5 MHz spacing



CMPA5585025F Power Dissipation De-rating Curve

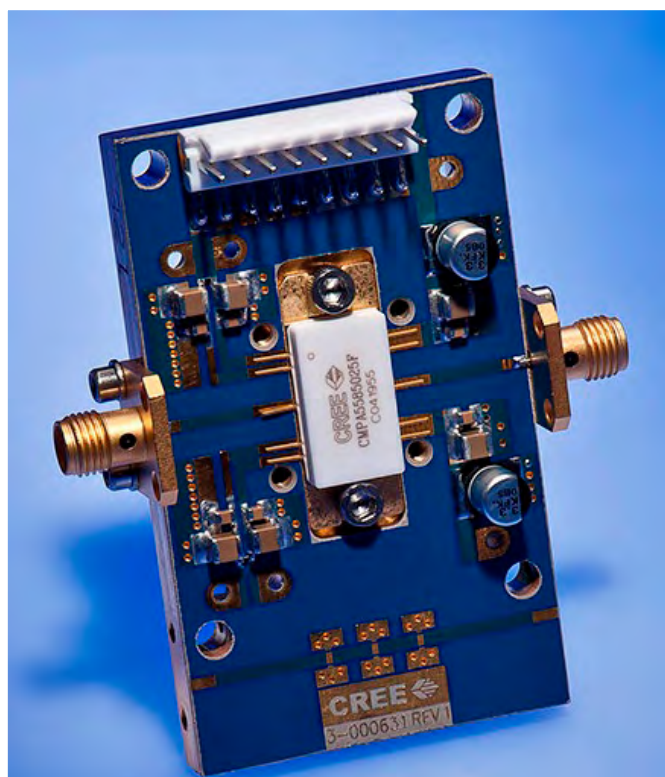


Note 1. Area exceeds Maximum Case Operating Temperature (See Page 2).

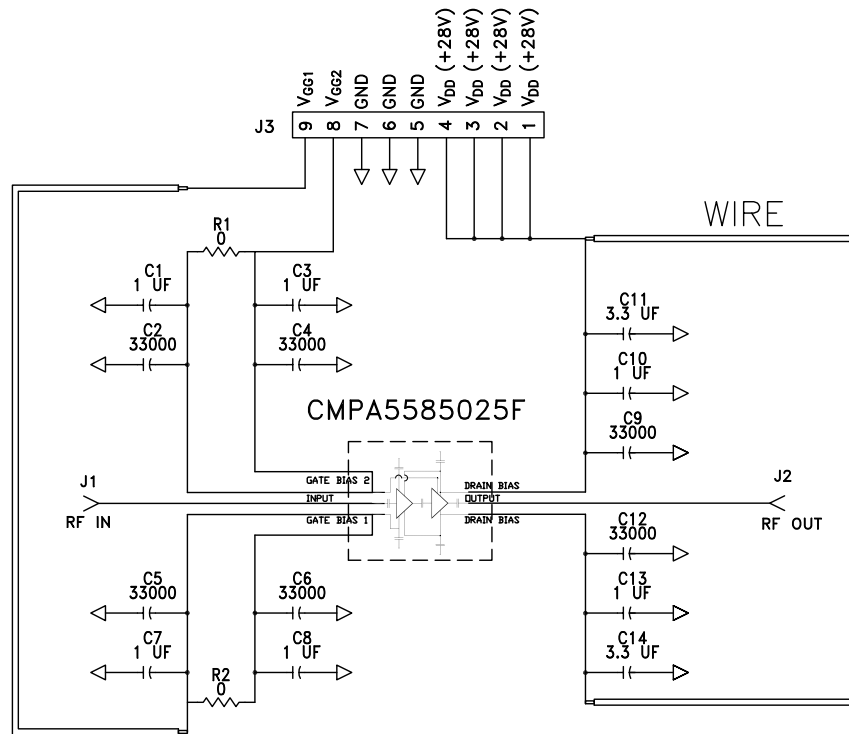
CMPA5585025F-TB Demonstration Amplifier Circuit Bill of Materials

Designator	Description	Qty
C1, C3, C7, C8, C10, C13	CAP, 1.0 uF, +/-10%, 1210, 100V, X7R	6
C2, C4, C5, C6, C9, C12	CAP, 33000 pF, 0805, 100V, X7R	6
C11, C14	CAP ELECT 3.3UF 80V FK SMD	2
R1, R2	RES 0.0 OHM 1/16W 0402 SMD	2
J1,J2	CONN, SMA, PANEL MOUNT JACK, FLANGE, 4-HOLE, BLUNT POST, 20MIL	2
J3	CONNECTOR, HEADER, RT>PLZ .1CEN LK 9POS	1
-	PCB, TACONIC, RF-35P-0200-CL1/CL1	1
Q1	CMPA5585025F	1

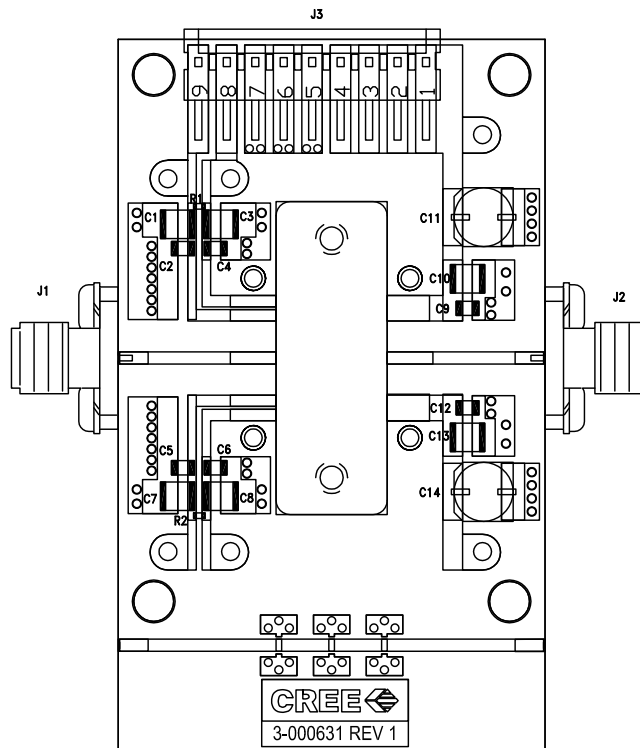
CMPA5585025F-TB Demonstration Amplifier Circuit



CMPA5585025F-TB Demonstration Amplifier Circuit

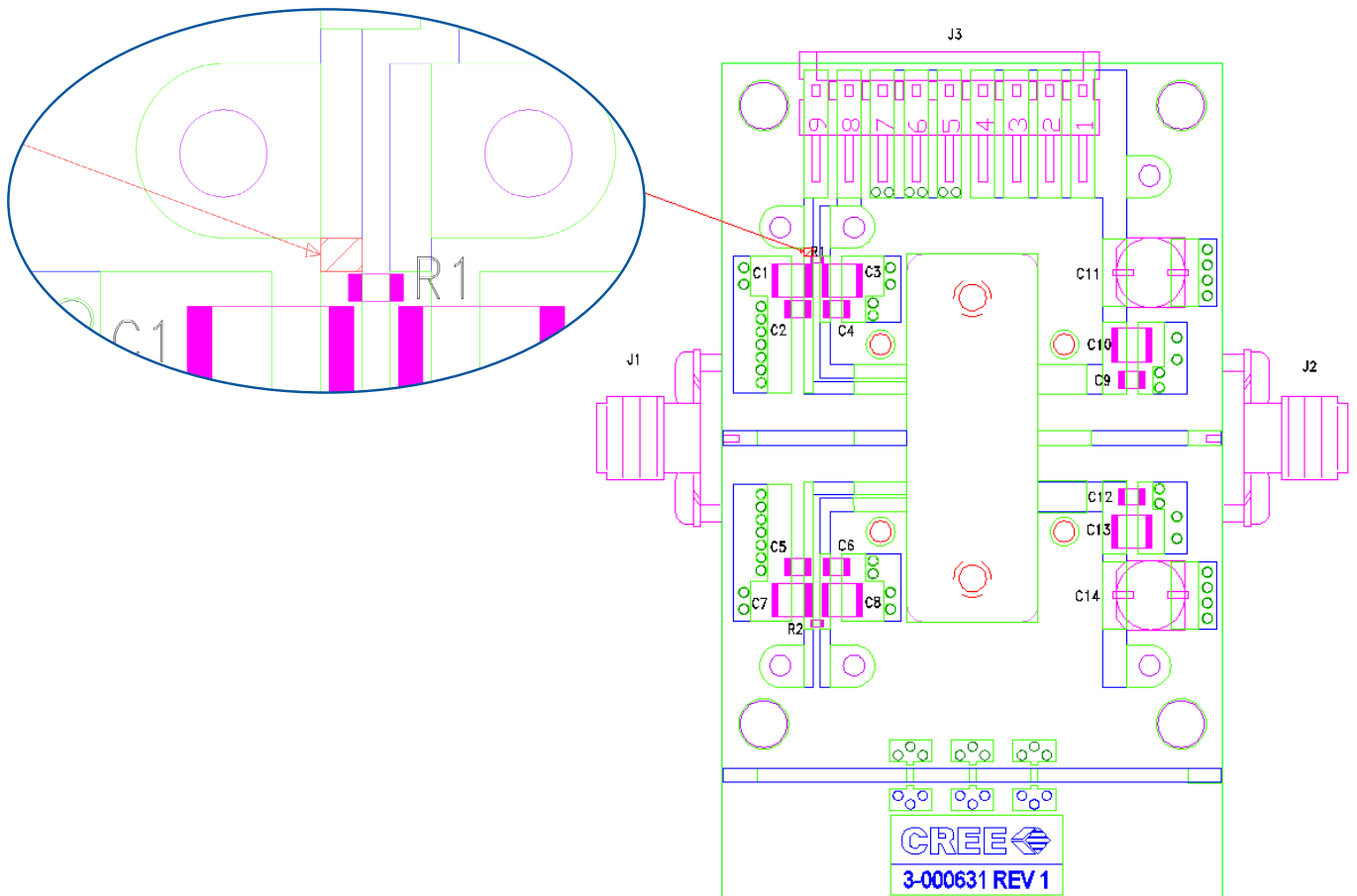


CMPA5585025F-TB Demonstration Amplifier Circuit Outline

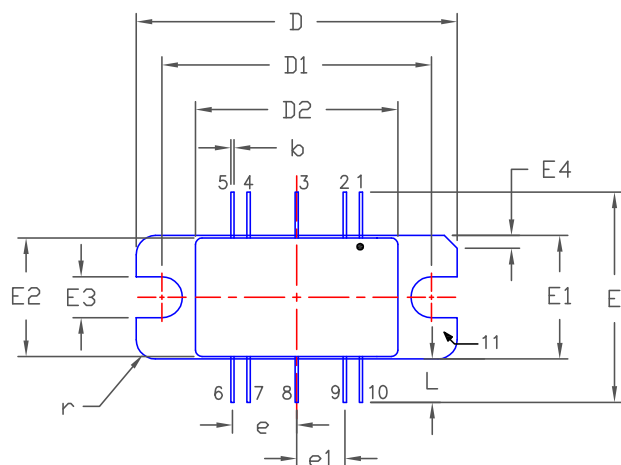


CMPA5585025F-TB Demonstration Amplifier Circuit

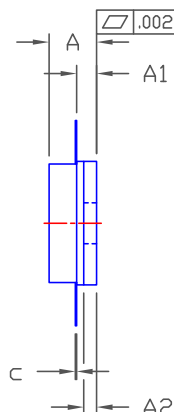
To configure the CMPA5585025F test fixture to enable independent V_{G1} / V_{G2} control of the device, a cut must be made to the microstrip line just above the R1 resistor as shown. Pin 9 will then supply V_{G1} and Pin 8 will supply V_{G2} .



Product Dimensions CMPA5585025F (Package Type — 440208)



- PIN 1. GATE BIAS
2. GATE BIAS
3. RF INPUT
4. GATE BIAS
5. GATE BIAS
6. DRAIN BIAS
7. DRAIN BIAS
8. RF OUTPUT
9. DRAIN BIAS
10. DRAIN BIAS
11. SOURCE

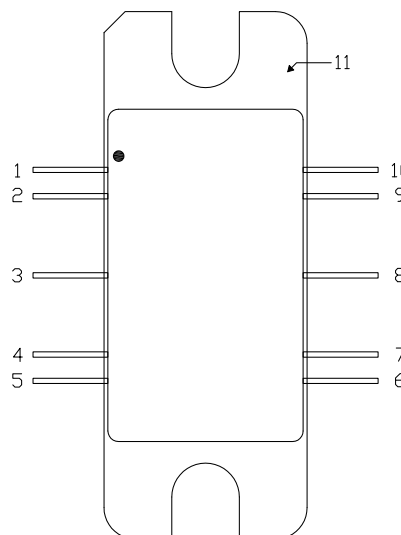


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M - 1994.
2. CONTROLLING DIMENSION: INCH.
3. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020" BEYOND EDGE OF LID.
4. LID MAY BE MISALIGNED TO THE BODY OF PACKAGE BY A MAXIMUM OF 0.008" IN ANY DIRECTION.

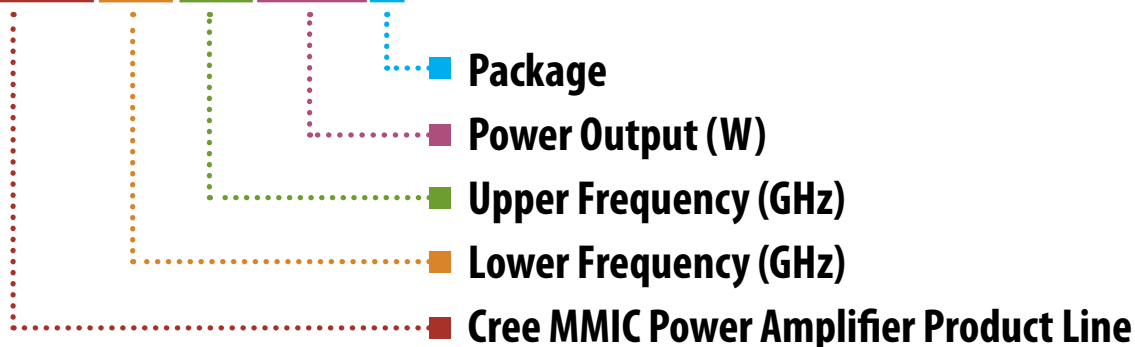
DIM	INCHES		MILLIMETERS		NOTES
	MIN	MAX	MIN	MAX	
A	0.138	0.158	3.51	4.01	
A1	0.057	0.067	1.45	1.70	
A2	0.035	0.045	0.89	1.14	
b	0.01 TYP		0.254 TYP		10x
c	0.003	0.006	0.08	0.15	
D	0.995	1.005	25.27	25.53	
D1	0.835	0.845	21.21	21.46	
D2	0.623	0.637	15.82	16.18	
E	0.654 TYP		16.61 TYP		
E1	0.380	0.390	9.65	9.91	
E2	0.365	0.375	9.72	9.53	
E3	0.123	0.133	3.12	3.38	
E4	0.035	0.045	0.89	1.14	
e	0.200 TYP		5.08 TYP		4x
e1	0.150 TYP		3.81 TYP		4x
L	0.115	0.155	2.92	3.94	10x
r	0.06 TYP		1.52 TYP		4x

Pin Number	Qty
1	Gate Bias for Stage 2
2	Gate Bias for Stage 2
3	RF In
4	Gate Bias for Stage 1
5	Gate Bias for Stage 1
6	Drain Bias
7	Drain Bias
8	RF Out
9	Drain Bias
10	Drain Bias
11	Source



Part Number System

CMPA5585025F



Parameter	Value	Units
Lower Frequency	5.5	GHz
Upper Frequency ¹	8.5	GHz
Power Output	25	W
Package	Flange	-

Table 1.

Note¹: Alpha characters used in frequency code indicate a value greater than 9.9 GHz. See Table 2 for value.

Character Code	Code Value
A	0
B	1
C	2
D	3
E	4
F	5
G	6
H	7
J	8
K	9
Examples:	1A = 10.0 GHz 2H = 27.0 GHz

Table 2.



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Наши преимущества:

- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели,
кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



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